

# amun Mira050

## Datasheet

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Tobelbader Strasse 30, 8141 Premstaetten, Austria

Phone +43 3136 500-0

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# Mira050 0.5 MP NIR-Enhanced high speed global shutter image sensor

## 1 General description

Mira050 is a compact 0.5 MP Near IR enhanced global shutter image sensor designed for 2D and 3D consumer and industrial machine vision applications. The sensor has a small 2.79  $\mu\text{m}$  pixel size with high sensitivity made possible by a state of the art BSI technology. The sensor has a MIPI CSI-2 interface to allow easy interfacing with a plethora of processors and FPGAs. Due to its small size, configurability and high sensitivity both in visual as well as NIR, the Mira050 is well suited for 2D and 3D applications, which include Active Stereo Vision, Structured Light Vision and AR/VR. High sensitivity in NIR enables increased measurement range and allows overall system power consumption optimization which is key for battery powered consumer and industrial applications.

## 2 Specifications & special features

Table 1: Key specifications

| Parameter                            | Value   | Remark   |
|--------------------------------------|---|--|
| Active pixels                        | 576 (H) x 768 (V) CSP<br>600 (H) x 800 (V) Bare Die | On CSP the addressable area is 600 x 800 but only 576 x768 is useable.                                     |
| Pixel                                | 2.79 $\mu\text{m}$ x 2.79 $\mu\text{m}$             | BSI stacked technology with high NIR sensitivity. Low noise and low cross talk                             |
| Optical format                       | 1/7"  |  |
| Dimensions                           | 2.25 mm x 2.75 mm – Die<br>2.29 mm x 2.83 mm – CSP  | Active area 60% of total.  |
| Shutter type                         | Voltage domain pipelined global shutter             | Possibility of exposure of next image during readout of the previous image.                                |
| Quantum efficiency (QE)              | 94 / 56 / 36 %                                      | 550 / 850 / 940 nm Mono  |
| Supported lens chief ray angle (CRA) | 0° to 30°   | Extra wide acceptance angle of the Mira050 pixel means any lens profile with these CRA values can be used. |
| ADC modes                            | 8-bit   10-bit   10-bit HS   12-bit                 |  |

| Parameter                             | Value   | Remark                                |
|---------------------------------------|---|---------------------------------------|
| Max frames per second full resolution | 120 fps   | All ADC modes                         |
| Analog gain                           | 1x → 4x step: 2x  | 12-bit   10-bit HS (Default mode)     |
|                                       | 1x → 16x step: 2x                                       | 10-bit (Default mode)                 |
|                                       | 1x → 4x step: 3%  | 10-bit HS (Fine gain mode)            |
|                                       | 1x → 32x step: 2x                                       | 8-bit (Default mode)                  |
|                                       | 1x → 16x step: 3%                                       | 8-bit (Fine gain mode)                |
| Digital gain                          | 1x → 16x step: 1/16x                                    | 8-bit   10-bit   10-bit HS   12-bit   |
| Data interface                        | MIPI CSI-2 v1.3 DPHY v1.2<br>1 Data lane   1 Clock lane | 1.5 Gbps with data scrambling support |

Table 2: Special features

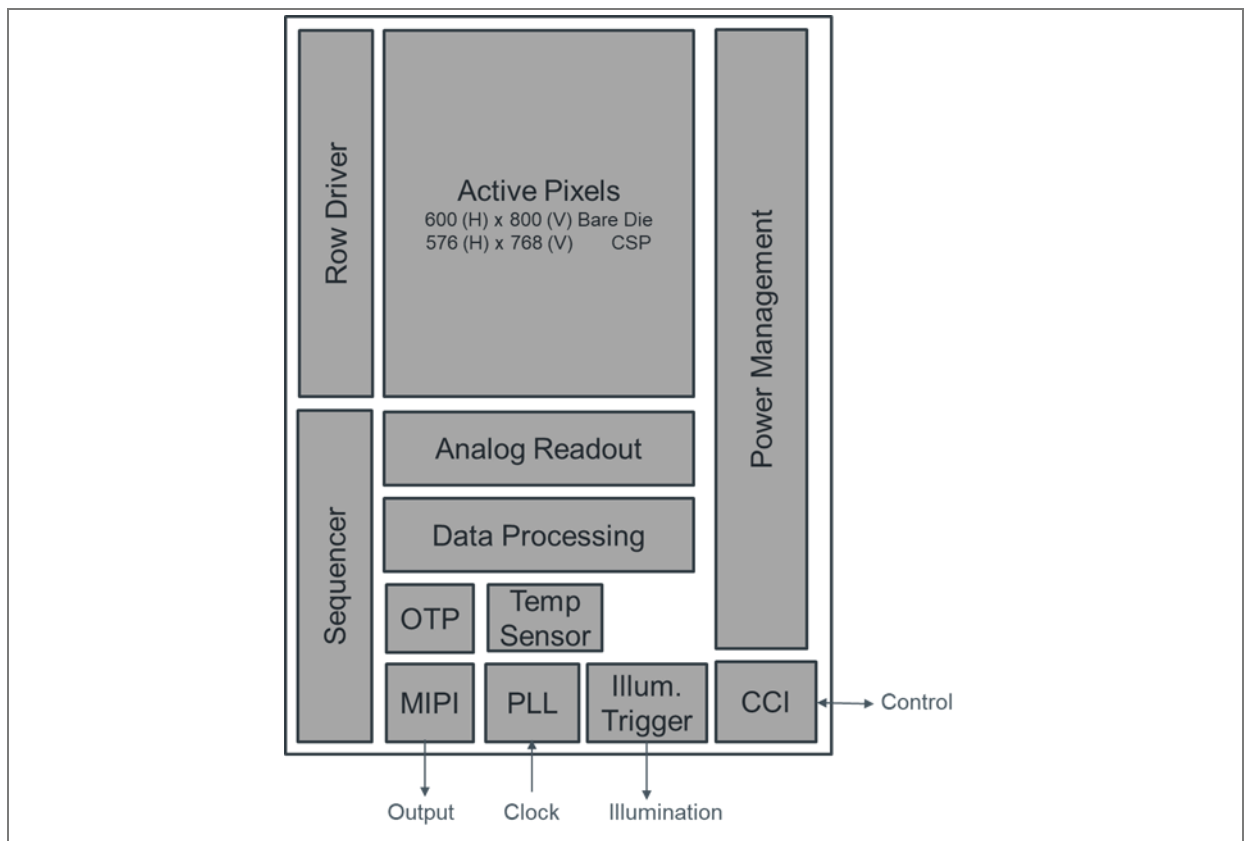
| Features                                | Benefits   |
|---|--|
| Programmable registers                  | Programming of window coordinates, timing parameters, exposure time, mirror, flipping, cropping  |
| High sensitivity and NIR enhanced pixel | High sensitivity and compact pixel size achieved via state of the art BSI technology with NIR enhancement resulting in less power hungry illuminators  |
| Context switching                       | Two register contexts for on the fly configuration changes   |
| On-chip processing                      | <ul style="list-style-type: none"><li>• Defect pixel detection and correction</li><li>• Image statistics generation</li><li>• Event detection</li><li>• In pixel background light cancellation</li><li>• Digital pixel binning</li><li>• Black sun protection</li><li>• Flexible ROI selection</li></ul> |
| On-chip advanced power management       | Smart powering of on chip blocks with respect to frame rate and exposure time resulting in extended battery life   |
| On-chip temperature sensor              | Accurate temperature reading on junction temperature   |
| Illumination synchronization trigger    | Accurate timing between illumination and actual exposure   |

## 3 Applications

- Facial authentication for mobile devices and points of payments.
- Active stereo and structured light vision (Robotics and other applications).
- Eye, head, hand, environment tracking for AR/VR.

## 4 Block diagram

Figure 1: Functional blocks of Mira050



# 5 Ordering information

| Product code         | Ordering code            | Package                        | Delivery form | Color filter | Delivery quantity |
|----------------------|--------------------------|--------------------------------|---------------|--------------|-------------------|
| Mira050-2QM3D0 RW    | 511930041<br>Q65113A8201 | Reconstructed wafer (bare die) | R/W           | None         | Upon request      |
| Mira050-2QM1WB FT SE | 511930039<br>Q65113A8197 | CSP                            | CSP           | None         | Multiples of 120  |
| Mira050-2QC3D0 RW    | 511930047<br>Q65113A8203 | Reconstructed wafer (bare die) | R/W           | RGB          | Upon request      |
| Mira050-2QC1WB FT SE | 511930045<br>Q65113A8202 | CSP                            | CSP           | RGB          | Multiples of 120  |
| Mira050-2QI3D0 RW    | 511930054<br>Q65113A8205 | Reconstructed wafer (bare die) | R/W           | RGB-IR       | Upon request      |
| Mira050-2QI1WB FT SE | 511930051<br>Q65113A8204 | CSP                            | CSP           | RGB-IR       | Multiples of 120  |

# 6 Revision information

| Document status       | Product status  | Definition  |
|-----------------------|-----------------|---|
| Product Preview       | Pre-development | Information in this datasheet is based on product ideas in the planning phase of development. All specifications are design goals without any warranty and are subject to change without notice   |
| Preliminary Datasheet | Pre-production  | Information in this datasheet is based on products in the design, validation or qualification phase of development. The performance and parameters shown in this document are preliminary without any warranty and are subject to change without notice |
| Datasheet             | Production      | Information in this datasheet is based on products in ramp-up to full production or full production which conform to specifications in accordance with the terms of ams-OSRAM AG standard warranty as given in the General Terms of Trade               |

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| Changes from previous released version to current revision v4-00 | Page |
|--|------|
| Updated ordering codes with color filter                         | 6    |

- Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.
- Correction of typographical errors is not explicitly mentioned.

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### Headquarters

ams-OSRAM AG  
Tobelbader Strasse 30  
8141 Premstaetten  
Austria, Europe  
Tel: +43 (0) 3136 500 0

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